

PowerCycling PC Series Thermoelectric Cooler

Note: This product is not recommended for new designs.

This product series has been replaced with the PowerCycling PCX Series.

The recommended replacement is: MFG Part Number: 387005675

Features

- High thermal cycling capability
- Precise temperature control
- Reliable solid-state operationNo sound or vibration
- RoHS-compliant

Applications

- Thermoelectric Modules Accelerate PCR Thermal Cycling
- DNA Amplification (PCR)



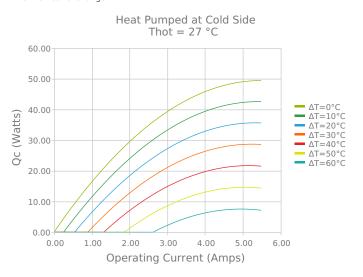
CERAMIC MATERIAL: Al₂O₃
SOLDER CONSTRUCTION: 232°C, SbSn

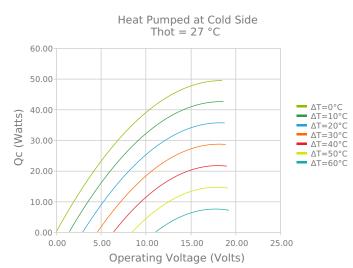
INCHES [MM]

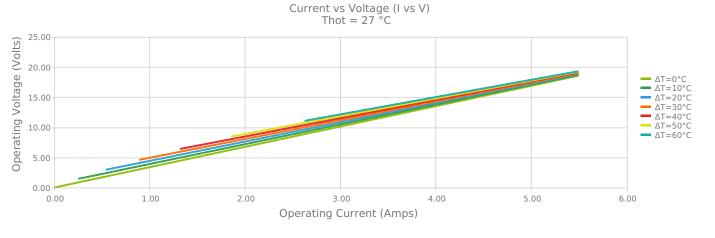
Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

ELECTRICAL AND THERMAL PERFORMANCE

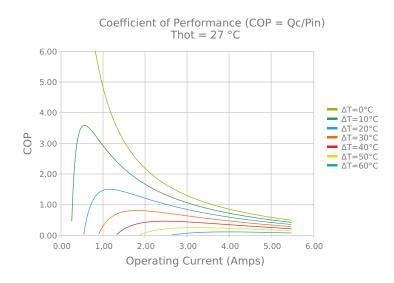
For maximum performance, be sure to orient the CONTROL side of the TEC against the application to be managed and the HEATSINK side against the heat sink or other heat rejection method. The CONTROL side is always opposite the side with lead attachments. Lead attachment is a passive heat loss and less impactful if located on the side that attaches to the heat exchanger.

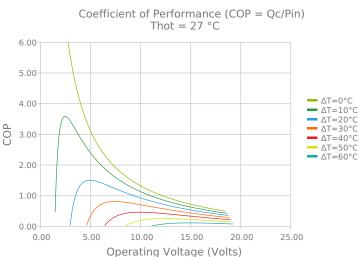


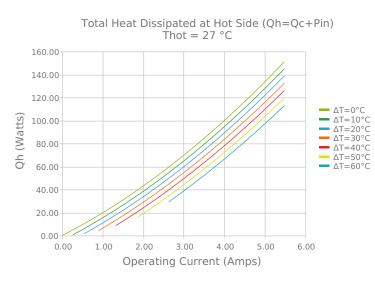


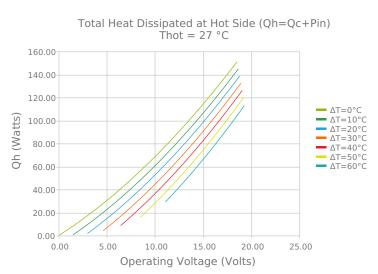


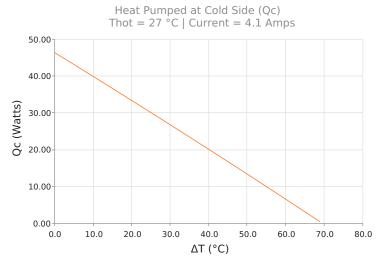


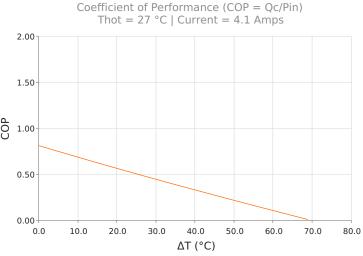














SPECIFICATIONS*

Hot Side Temperature

 $Qcmax (\Delta T = 0)$

 $\Delta T max (Qc = 0)$

Imax (I @ ATmax)

Vmax (V @ Δ Tmax)

Module Resistance

Max Operating Temperature

Weight

27.0 °C	50.0 °C	80.0 °C
49.4 Watts	53.6 Watts	58.1 Watts
70.5°C	78.8°C	88.8°C
4.8 Amps	4.8 Amps	4.7 Amps
17.6 Volts	19.5 Volts	22.0 Volts
3.38 Ohms	3.78 Ohms	4.31 Ohms
120 °C		
20.0 gram(s)		

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
TA	3.700 ±0.025 mm 0.146 ± 0.0010 in	0.025 mm / 0.025 mm 0.001 in / 0.001 in	Lapped	Lapped	152.4 mm 6.00 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
RT	RTV	Translucent or White	-60 to 204°C	Non-corrosive, silicone adhesive

NOTES

- 1. Max operating temperature: 120°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation
- 4. Solder tinning also available on metallized ceramics

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^{*} Specifications reflect thermoelectric coefficients updated March 2020